

HLMP-3707, HLMP-3907, HLMP-3750, HLMP-3850, HLMP-3950, HLMP-3960, HLMP-3390, HLMP-3490, HLMP-3590, HLMP-1340, HLMP-1440, HLMP-1540, HLMP-K640

T-1<sup>3</sup>/<sub>4</sub> (5 mm), T-1 (3 mm), Ultra-Bright LED Lamps



### Description

These Broadcom<sup>®</sup> non-diffused lamps out-perform conventional LED lamps. By using new higher intensity material, superior product performance is achieved.

#### **Features**

- Improved brightness
- Improved color performance
- Available in popular T-1 and T-1<sup>3</sup>/<sub>4</sub> packages
- New sturdy leads
- IC compatible/low current capability
- Reliable and rugged
- Choice of three bright colors
  - Red
  - Yellow
  - Green

### **Applications**

- Lighted switches
- Backlighting front panels
- Light pipe sources
- Keyboard indicators

### **Data Sheet**

### **Package Dimensions**

Figure 1: Package Outline "A" HLMP-3750/3850/3950



Figure 2: Package Outline "B" HLMP-3390/3490/3590







#### NOTE:

- 1. All dimensions are in millimeters (inches).
- 2. An epoxy meniscus may extend about 1 mm (0.04 in.) down the leads.
- 3. For PCB hole recommendations, see Precautions.



6.10 (0.240) 5.60 (0.220)

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.54 (0.100) NOM.

#### T-1¾ (5 mm), T-1 (3 mm), Ultra-Bright LED Lamps

# Figure 6: Package Outline "F"



#### NOTE:

1. All dimensions are in millimeters (inches).

6.10 (0.240)

5.59 (0.220)

2.54 (0.100) NOM.

2. An epoxy meniscus may extend about 1 mm (0.04 in.) down the leads.

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3. For PCB hole recommendations, see Precautions.

### **Device Selection Guide**

			Luminous II	ntensity Iv (m	Viewing		
Package Description	Color	Device HLMP-	Min.	Тур.	Max.	$2\theta_{1/2}$ (Degrees)	Package Outline
T-1¾	Red	3707-L00xx	90.2		—	24	F
		3750	90.2	125.0		24	А
		3750-L00xx	90.2	125.0	—	24	А
	Yellow	3850	96.2	140.0	—	24	А
		3850-K00xx	96.2	140.0	—	24	А
	Green	3914	111.7	_	—	24	D
		3950	111.7	265.0	—	24	А
		3950-K00xx	111.7	265.0		24	А
		3960-K0xxx	111.7	265.0		24	E
T-1¾ Low Profile	Red	3390	35.2	55.0	—	32	В
	Yellow	3490	37.6	55.0		32	В
	Green	3590	43.6	55.0		32	В
T-1	Red	1340	35.2	55.0	—	45	С
		1340-J00xx	35.2	55.0	—	45	С
	Yellow	1440	23.5	45.0	—	45	С
		1440-H00xx	23.5	45.0	—	45	С
	Green	1540	27.3	45.0		45	С
		1540-H00xx	27.3	45.0	—	45	С
		1540-IJ000	43.6	60.0	139.6	45	С
	Emerald Green	K640	4.2	21.0	—	45	С

### Absolute Maximum Ratings at $T_A = 25^{\circ}C$

Parameter	Red	Yellow	Green/Emerald Green	Units
Peak Forward Current	90	60	90	mA
Average Forward Current <sup>a</sup>	25	20	25	mA
DC Current <sup>b</sup>	30	20	30	mA
Reverse Voltage (I <sub>R</sub> = 100 µA)	5	5	5	V
LED Junction Temperature	110	110	110	°C
Operating Temperature Range	-40 to +100	-40 to +100	-20 to +100	°C
Storage Temperature Range	-40 to +100	-40 to +100	-40 to +100	°C

a. See Figure 8 to establish pulsed operating conditions.

b. For Red and Green series, derate linearly from 50°C at 0.5 mA/°C. For Yellow series, derate linearly from 50°C at 0.2 mA/°C.

# Electrical/Optical Characteristics at $T_A = 25^{\circ}C$

Parameter	Symbol	<b>T-1</b> ¾	T-1¾ Low Dome	T-1	Min.	Тур.	Max.	Units	Test Conditions
Peak	λρεακ	37xx	3390	1340	—	632	—	nm	Measurement at
Wavelength		38xx	3490	1440	_	590	_		Peak
		39xx	3590	1540	—	570	—		
				K640	—	560	—		
Dominant	λ <sub>d</sub>	37xx	3390	1340	_	626	_	nm	Note <sup>a</sup>
Wavelength		38xx	3490	1440	—	589	—		
		39xx	3590	1540	—	569	—		
				K640	_	559	_		
Spectral	$\Delta\lambda_{3/4}$	37xx	3390	1340	—	14	—	nm	
Line		38xx	3490	1440	—	12	—		
Halfwidth		39xx	3590	1540	_	13			
				K640	_	13			
Speed of	$\tau_{s}$	37xx	3390	1340	_	90	_	ns	
Respond		38xx	3490	1440		90			
		39xx	3590	1540		500			
				K640		3100		1	
Capacitance	С	37xx	3390	1340	_	11		pF	V <sub>F</sub> = 0, f = 1 MHz
	_	38xx	3490	1440		15			
		39xx	3590	1540		18			
				K640	_	35			
Thermal	$R\theta_{J-PIN}$	37xx	3390			210		°C/W	Junction to
Resistance		38xx	3490			210			Cathode Lead
		39xx	3590			210			
				1340		290			
				1440	_	290			
				1540	_	290	_		
				K640		290			
Forward	V <sub>F</sub>	37xx	3390	1340	1.5	2.0	2.6	V	I <sub>F</sub> = 20 mA
Voltage		38xx	3490	1440	1.5	2.0	2.6		
		39xx	3590	1540	1.5	2.1	3.0		
				K640		2.2	3.0		
Reverse	V <sub>R</sub>	37xx	3390	1340	5.0	—		V	I <sub>R</sub> = 100 μA
Breakdown		38xx	3490	1440					
Voltage		39xx	3590	1540					
				K640					
Luminous	η <sub>v</sub>	37xx	3390	1340		180		lumens/	Note <sup>b</sup>
Efficacy	- •	38xx	3490	1440	_	500	_	watt	
		39xx	3590	1540	_	640	_	1	
				K640	_	660	—	1	

a. The dominant wavelength,  $\lambda_d$ , is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

b. The radiant intensity, le, in watts per steradian, may be found from the equation le =  $I_v / \eta_V$ , where  $I_v$  is the luminous intensity in candelas and  $\eta_V$  is the luminous efficacy in lumens/watt.

### Part Numbering System

H L M P - X<sub>1</sub> X<sub>2</sub> X<sub>3</sub> X<sub>4</sub> - X<sub>5</sub> X<sub>6</sub> X<sub>7</sub> X<sub>8</sub>

Code	Description	Option	
x <sub>1</sub>	Package Type	1	T-1 (3 mm)
		К	T-1 (3 mm)
		3	T-1¾ (5 mm)
x <sub>2</sub>	Color	3, 7	Red
		4, 8	Yellow
		5, 9	Green
		6	Emerald Green
x <sub>3</sub> x <sub>4</sub>	Product Specific Designation	<u> </u>	
x <sub>5</sub>	Minimum Intensity Bin	See Intensity Bin Limits	
x <sub>6</sub>	K <sub>6</sub> Maximum Intensity Bin		Open (no maximum limit)
		Others	See Intensity Bin Limits
x <sub>7</sub>	Color Bin Selection	0	Full range
x <sub>8</sub> x <sub>9</sub>	Packaging Option	00	Bulk packaging
		01	Tape and reel, crimped leads
		02	Tape and reel, straight leads
		A1	Right angle housing, uneven leads
		A2, B2	Right angle housing, even leads

x<sub>9</sub>

# **Intensity Bin Limits**

		Intensity Range (mcd)	
Color	Bin	Min.	Max.
Red	G	9.7	15.5
	Н	15.5	24.8
	I	24.8	39.6
	J	39.6	63.4
	К	63.4	101.5
	L	101.5	162.4
	М	162.4	234.6
	N	234.6	340.0
	0	340.0	540.0
	Р	540.0	850.0
	Q	850.0	1200.0
	R	1200.0	1700.0
	S	1700.0	2400.0
	Т	2400.0	3400.0
	U	3400.0	4900.0
	V	4900.0	7100.0
	W	7100.0	10200.0
	Х	10200.0	14800.0
	Y	14800.0	21400.0
	Z	21400.0	30900.0
Yellow	F	10.3	16.6
	G	16.6	26.5
	Н	26.5	42.3
	I	42.3	67.7
	J	67.7	108.2
	К	108.2	173.2
	L	173.2	250.0
	М	250.0	360.0
	N	360.0	510.0
	0	510.0	800.0
	Р	800.0	1250.0
	Q	1250.0	1800.0
	R	1800.0	2900.0
	S	2900.0	4700.0
	Т	4700.0	7200.0
	U	7200.0	11700.0
	V	11700.0	18000.0
	W	18000.0	27000.0

		Intensity Range (mcd)	
Color	Bin	Min.	Max.
Green/	А	1.1	1.8
Emerald Green	В	1.8	2.9
	С	2.9	4.7
	D	4.7	7.6
	E	7.6	12.0
	F	12.0	19.1
	G	19.1	30.7
	Н	30.7	49.1
	I	49.1	78.5
	J	78.5	125.7
	К	125.7	201.1
	L	201.1	289.0
	М	289.0	417.0
	Ν	417.0	680.0
	0	680.0	1100.0
	Р	1100.0	1800.0
	Q	1800.0	2700.0
	R	2700.0	4300.0
	S	4300.0	6800.0
	Т	6800.0	10800.0
	U	10800.0	16000.0
	V	16000.0	25000.0
	W	25000.0	40000.0

Maximum tolerance for each bin limit is  $\pm$  18%.

### **Color Categories**

		Lambda (nm)	
Color	Cat #	Min.	Max.
Emerald Green	9	552.5	555.5
	8	555.5	558.5
	7	558.5	561.5
	6	561.5	564.5
Green	6	561.5	564.5
	5	564.5	567.5
	4	567.5	570.5
	3	570.5	573.5
	2	573.5	576.5
Yellow	1	582.0	584.5
	3	584.5	587.0
	2	587.0	589.5
	4	589.5	592.0
	5	592.0	593.0

		Lambda (nm)		
Color	Cat #	Min.	Max.	
Orange	1	597.0	599.5	
	2	599.5	602.0	
	3	602.0	604.5	
	4	604.5	607.5	
	5	607.5	610.5	
	6	610.5	613.5	
	7	613.5	616.5	
	8	616.5	619.5	

Tolerance for each bin limit is  $\pm 0.5$  nm.

### **Packaging Option Matrix**

Packaging Option Code	Definition
00	Bulk Packaging, minimum increment 500 pieces/bag
01	Tape and Reel, crimped leads, min. increment 1300 pieces/reel for T-1¾, 1800 pieces/reel for T-1
02	Tape and Reel, straight leads, min. increment 1300 pieces/reel for T-1¾, 1800 pieces/reel for T-1
A1	T-1, Right Angle Housing, uneven leads, minimum increment 500 pieces/bag
A2	T-1, Right Angle Housing, even leads, minimum increment 500 pieces/bag
B2	T-1¾, Right Angle Housing, even leads, minimum increment 500 pieces/bag

**NOTE:** All categories are established for classification of products. Products may not be available in all categories. Contact your local Broadcom representative for further clarification and information.

#### Figure 7: Relative Intensity vs. Wavelength



Figure 8: Maximum Tolerable Peak Current vs. Pulse Duration ( $I_{DC}$  MAX as per MAX Ratings)



Figure 10: Relative Luminous Intensity vs. Forward Current



#### Figure 9: Forward Current vs. Forward Voltage







#### T-1¾ (5 mm), T-1 (3 mm), Ultra-Bright LED Lamps

# Figure 12: Relative Luminous Intensity vs. Angular Displacement, T-1<sup>3</sup>/<sub>4</sub> Low Profile Lamp



# Figure 13: Relative Luminous Intensity vs. Angular Displacement, T-1 Lamp



## Packaging Label

### **Mother Label**

Available on packaging box of ammo pack and shipping box.

(1P) Item: Part Number		STANDARD LABEL LS0002 RoHS Compliant e3 max temp 250C
(1T) Lot: Lot Number		(Q) QTY: Quantity 
LPN: 		CAT: Intensity Bin
(9D)MFG Date: Manufacturing Date		BIN: Color Bin
(P) Customer Item:		
(V) Vendor ID: 	(9D) Date	e Code: Date Code
DeptID:	Made In:	Country of Origin

### **Baby Label**

Only available on bulk packaging.

Lamps Baby Label	RoHS Compliant
(1P) PART #: Part Number	
(1T) LOT #: Lot Number 	
(9D)MFG DATE: Manufacturing Date	QUANTITY: Packing Quantity
C/O: Country of Origin	
Customer P/N:	CAT: Intensity Bin
Supplier Code:	BIN: Color Bin
	DATECODE: Date Code

# Precautions

### Lead Forming

- Preform or cut the leads of an LED lamp to length prior to insertion and soldering on PC board.
- For better control, use proper tool to precisely form and cut the leads to applicable length rather than doing it manually.
- If manual lead cutting is necessary, cut the leads after the soldering process. The solder connection forms a mechanical ground that prevents mechanical stress due to lead cutting from traveling into LED package. This is highly recommended for hand solder operation, as the excess lead length also acts as small heat sink.

### **Soldering and Handling**

- Take care during PCB assembly and soldering process to prevent damage to the LED component.
- The LED component may be effectively hand soldered to PCB. However, it is only recommended under unavoidable circumstances, such as rework. The closest manual soldering distance of the soldering heat source (soldering iron's tip) to the body is 1.59 mm. Soldering the LED using soldering iron tip closer than 1.59 mm might damage the LED.



- Apply proper ESD precaution on the soldering station and by personnel to prevent ESD damage to the LED component that is ESD sensitive. For details, refer to Broadcom Application Note 1142. The soldering iron used should have a grounded tip to ensure electrostatic charge is properly grounded.
- Recommended soldering conditions follow.

	Wave Soldering <sup>a</sup> , <sup>b</sup>	Manual Solder Dipping
Pre-heat Temperature	105°C max.	—
Pre-heat Time	60s max.	—
Peak Temperature	250°C max.	260°C Max.
Dwell Time	3s max.	5s Max.

- a. These conditions refer to measurement with a thermocouple mounted at the bottom of PCB.
- b. To reduce thermal stress experienced by the LED, it is recommended that you use only the bottom preheaters.

 Set and maintain wave soldering parameters according to the recommended temperature and dwell time.
 Perform daily checks on the soldering profile to ensure that it is always conforming to recommended soldering conditions.

#### NOTE:

- PCBs with different size and design (component density) will have different heat mass (heat capacity). This might cause a change in temperature experienced by the board if same wave soldering setting is used. So, you should recalibrate the soldering profile again before loading a new type of PCB.
- Take extra precautions during wave soldering to ensure that the maximum wave temperature does not exceed 250°C and the solder contact time does not exceeding 3s. Over-stressing the LED during soldering process might cause premature failure to the LED due to delamination.
- Any alignment fixture that is being applied during wave soldering should be loosely fitted and should not apply weight or force on the LED. Nonmetal material is recommended as it will absorb less heat during wave soldering process.
- At elevated temperature, the LED is more susceptible to mechanical stress. Therefore, PCB must allowed to cool down to room temperature prior to handling, which includes removal of alignment fixture or pallet.
- If PCB board contains both through hole (TH) LED and other surface mount components, solder surface-mount components on the top side of the PCB. If surfacemount must be on the bottom side, solder these components using reflow soldering prior to insertion the TH LED.
- The following are the recommended PC board plated through holes (PTH) size for LED component leads.

	LED Component Lead Size	Diagonal	Plated Through- Hole Diameter
Lead size (typ.)	0.45 × 0.45 mm	0.636 mm	0.98 to 1.08 mm
	(0.018 × 0.018 in.)	(0.025 in.)	(0.039 to 0.043 in.)
Dambar shear-	0.65 mm	0.919 mm	
off area (max.)	(0.026 in.)	(0.036 in.)	
Lead size (typ.)	0.50 × 0.50 mm	0.707 mm	1.05 to 1.15 mm
	(0.020 × 0.020 in.)	(0.028 in.)	(0.041 to 0.045 in.)
Dambar shear-	0.70 mm	0.99 mm	
off area (max.)	(0.028 in.)	(0.039 in.)	

 Over-sizing the PTH can lead to a twisted LED after it is clinched. On the other hand, undersizing the PTH can make inserting the TH LED difficult.

For more information about soldering and handling of TH LED lamps, refer to Application Note 5334.

### **Example of Wave Soldering Temperature Profile for TH LED**



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